

EAO Sub-mm Futures, May. 20-23, 2019

A Planar Integrated SIS Heterodyne Array for Wide FOV Observation

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Heterodyne Receivers With SIS Mixer





Combination of Large FoV and High Sensitivity







Very sensitive coherent detector: Superconductor -Insulator-Superconductor Tunnel Junction





SIS Mixer Fabrication



Superconducting Spectroscopic Array Receiver (SSAR) :Sideband Separation (2SB) SIS Mixers











Integration of the frontend





LO Distribution Concept Design



This approach eliminates the difficulty in machining waveguide structures, paves the road to a large amount of pixels.



Membrane-based Waveguide Probes





2mm Band Mixer Chip Layout



SEM image credit: Shohei Ezaki, NAOJ



The size of this chip is 13 mm x 10 mm x 0.4 mm.





Circuit diagram of the mixer chip



The mixer is configured as a balanced mixer.





Free-standing Membrane



(a)

(b)

The SEM image of the backshort piece for (a) signal waveguide probe and for (b) the LO waveguide probe. The membrane about the LO waveguide backshort is inventively cracked to show the clearance between the membrane and the metal block.



Demonstration of Performance (OMT)



Planar OMT



Polarization selectivity measurement



X-Polar level < -23 dB is achieved.





Balanced Mixing: Signal Selectivity





Balanced Mixer: Noise



The low-noise performance is approaching ALMA specification.





Balanced Mixing: A solution of LO power requirement



Balanced Mixer (50% LO usage)



Single-ended Mixer (1-5% of LO usage)

Freq. Range	LO Pw	Pw per Jun.	Jun per pixel	Max Num
140-220 GHz	3 mW	0.05 uW	8	7500
400-600 GHz	1.5 mW	0.36 uW	8	520
750-1000 GHz	0.25 mW	1 uW	8	31





Road Map of This Work



Sub-millimeter wavelength

For interferometers





Other Technical Challenges

- Wide FOV optics
- Low power-consumption and low-cost amplifiers
- Multiplexing of IF output (radio-over-fiber)
- Spectrometer technologies





Reduction of LNA power from 20 mA to 1 mA



The photograph of the GaAs LNA chip. Size is 1 $mm \times 2.4 mm$.





- Band: 2.5-4.5 GHz;
- Average noise temperature of 12 K;
- Gain > 20 dB; Dissipation of 1.2 mW.





Conclusion

New concept is proposed and verified for SIS multibeam receivers.

The goal of this work is to implement this technology to the future large single-dish mm-submm radio telescopes and inteferometers.

